## Octal Multiprotocol Switch

The Intersil ISL54230 is a multiprotocol Quad Double-Pole Double-Throw (DPDT) analog switch that can operate from a single +2.0 V to +5.5 V supply. It contains eight SPDT (Single Pole/Double Throw) switches configured into four DPDT blocks. Each DPDT block is independently controlled by a logic input for Normally Open (NO) or Normally Closed (NC) switch configuration. The part is designed for switching or routing a combination of USB High-Speed, USB Full-Speed, digital, and analog signals in portable battery powered products.

The digital inputs are 1.8 V logic compatible when operated with a 2.7 V to 3.6 V supply. The ISL54230 has two switch enable pins to disable certain blocks of the switch. The ISL54230 is available in a 36 ball $2.5 \mathrm{~mm} \times 2.5 \mathrm{~mm}$ WLCSP or a 32 Ld TQFN $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ package. It operates over a temperature range of -40 to $+85^{\circ} \mathrm{C}$.

## Applications

- Cellular/Mobile Phones
- PDAs
- Digital Cameras and Camcorders
- USB/UART/Audio Switching


## Block Diagram



## Features

- High Speed (480Mbps) and Full Speed (12Mbps) Signaling Capability per USB 2.0
- Compliant with USB 2.0 Short Circuit and Overvoltage Requirements Without Additional External Components
- 1.8 V Logic Compatible (+2.7V to +3.6V Supply)
- Switch Terminals Overvoltage Protected Up to +5.5 V
- Enable Pin to disable Switch Blocks
- Two DPDT $1 \Omega / 6 \Omega$ Switches
- Two DPDT USB 2.0 FS/HS Capable Switches
- USB Switch Low ON Capacitance. . . . . . . . . . . . . . . 12pF
- USB Switch Low ON-Resistance. . . . . . . . . . . . . . . . . $6 \Omega$
- Single Supply Operation ( $\mathrm{V}_{\mathrm{DD}}$ ) . . . . . . . . . . +2.0 V to +5.5 V
- Low Power Consumption ( $\mathrm{P}_{\mathrm{D}}$ ) . . . . . . . . . . . . . . . . . . $1 \mu \mathrm{~A}$
- Low I+ Current when $\mathrm{V}_{\mathrm{INH}}$ is not at the V+ Rail
- Available in 36 Ball WLCSP and 32 Ld 5mmx5mm TQFN Package
- Pb-Free (RoHS Compliant)


## Ordering Information

| PART NUMBER | PART <br> MARKING | TEMP. <br> RANGE <br> ( $\left.{ }^{\circ} \mathrm{C}\right)$ | PACKAGE <br> (Pb-Free) | PKG. <br> DWG. \# |
| :--- | :--- | :--- | :--- | :--- |
| ISL54230IRTZ <br> (Note 1) | 54230 IRTZ | -40 to +85 | 32 Ld 5x5 TQFN | L32.5x5A |
| ISL54230IRTZ-T* <br> (Note 1) | 54230 IRTZ | -40 to +85 | 32 Ld 5x5 TQFN | L32.5x5A |
| ISL54230IIZ-T* <br> (Note 2) | $230 Z$ | -40 to +85 | 36 Ball 6x6 Array <br> WLCSP | W6x6.36 |

*Please refer to TB347 for details on reel specifications. NOTES:

1. These Intersil Pb-free plastic packaged products employ special Pb free material sets, molding compounds/die attach materials, and $100 \%$ matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb -free soldering operations). Intersil Pb -free products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb free requirements of IPC/JEDEC J STD-020.
2. These Intersil Pb-free WLCSP and BGA packaged products products employ special Pb -free material sets; molding compounds/die attach materials and SnAgCu - e1 solder ball terminals, which are RoHS compliant and compatible with both SnPb and Pb -free soldering operations. Intersil Pb-free WLCSP and BGA packaged products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb -free requirements of IPC/JEDEC J STD-020.

## Pinouts

ISL54230
*Columns A, B, C = Left Plane *Columns D, E, F = Right Plane *Refer to OE Control Truth Table, pg. 3


ISL54230
(32 LD 5X5 TQFN)
TOP VIEW


## Pinouts



NOTE: Switches shown in Logic "0" position. Logic "0" when INx $<0.5 \mathrm{~V}$

Input Select Truth Table

| INx | NOx | NCx |
| :---: | :---: | :---: |
| 0 | OFF | ON |
| 1 | ON | OFF |

Logic "0" when $\leq 0.5 \mathrm{~V}$, Logic " 1 " when $\geq 1.4 \mathrm{~V}$ with a 2.7 V to 3.6 V Supply.


OE Control Truth Table

| OE1 | OE2 | SWITCH <br> ON | SWITCH <br> OFF | MODE, <br> WLCSP | MODE, <br> TQFN |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | COM2x, <br> COM3x | COM1x, <br> COM4x | USB | USB |
| 0 | 1 | COM3x, <br> COM4x | COM1x, <br> COM2x | Right <br> Plane | Left <br> Plane |
| 1 | 0 | COM1x, <br> COM2x | COM3x, <br> COM4x | Left <br> Plane | Right <br> Plane |
| 1 | 1 | ALL | NONE | All On | All On |

Logic " 0 " when $\leq 0.5 \mathrm{~V}$, Logic " 1 " when $\geq 1.4 \mathrm{~V}$ with a 2.7 V to 3.6 V Supply.

## Pin Descriptions

| PIN NAME | COLUMN-ROW <br> WLCSP | PIN NUMBER <br> TQFN | DESCRIPTION |
| :---: | :---: | :---: | :--- |
| VDD | C5 | 14 | Power Supply Pin |
| GND | D5 | 11 | Ground Connection |
| OE1 | C2 | 27 | Switch Enable Control 1 |
| OE2 | D2 | 30 | Switch Enable Control 2 |
| IN1 | B6 | 15 | Switch Input Select 1 |
| IN2 | C6 | 13 | Switch Input Select 2 |
| IN3 | D6 | 12 | Switch Input Select 3 |
| IN4 | E6 | 10 | Switch Input Select 4 |
| COM_1A | A2 | 23 | HS Switch Common 1A |
| COM_1B | C1 | 28 | HS Switch Common 1B |

Pin Descriptions (Continued)

| PIN NAME | COLUMN-ROW WLCSP | PIN NUMBER TQFN | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| COM_2A | A1 | 25 | HS Switch Common 2A |
| COM_2B | B1 | 26 | HS Switch Common 2B |
| COM_3A | F1 | 32 | $6 \Omega$ Switch Common 3A |
| COM_3B | E1 | 31 | $1 \Omega$ Switch Common 3B |
| COM_4A | F2 | 2 | $6 \Omega$ Switch Common 4A |
| COM_4B | D1 | 29 | $1 \Omega$ Switch Common 4B |
| NC_1A | B2 | 24 | Switch Normally Closed 1A |
| NC_1B | B5 | 17 | Switch Normally Closed 1B |
| NC_2A | B3 | 22 | Switch Normally Closed 2A |
| NC_2B | B4 | 19 | Switch Normally Closed 2B |
| NC_3A | E3 | 3 | Switch Normally Closed 3A |
| NC_3B | E4 | 6 | Switch Normally Closed 3B |
| NC_4A | E2 | 1 | Switch Normally Closed 4A |
| NC_4B | E5 | 8 | Switch Normally Closed 4B |
| NO_1A | A3 | 21 | Switch Normally Open 1A |
| NO_1B | A6 | 16 | Switch Normally Open 1B |
| NO_2A | A4 | 20 | Switch Normally Open 2A |
| NO_2B | A5 | 18 | Switch Normally Open 2B |
| NO_3A | F4 | 5 | Switch Normally Open 3A |
| NO_3B | F5 | 7 | Switch Normally Open 3B |
| NO_4A | F3 | 4 | Switch Normally Open 4A |
| NO_4B | F6 | 9 | Switch Normally Open 4B |
| N.C. | C3, C4, D3, D4 |  | No Connect |


| Absolute Maximum Ratings |  |
| :---: | :---: |
| $V_{\text {DD }}$ to GND. | -0.3 V to +6.5 V |
| Input Voltages |  |
| NCx, NOx (Note 3) | - 0.3 V to +6.5 V |
| INx, OEx (Note 3). | -0.3V to +6.5V |
| Output Voltages |  |
| COMx (Note 3) | -0.3V to +6.5V |
| Continuous Current (NC2x, NO3x) | $\pm 40 \mathrm{~mA}$ |
| Continuous Current (NC1x, NO4x) | $\pm 150 \mathrm{~mA}$ |
| Peak Current (NC2x, NO3x) |  |
| (Pulsed 1ms, 10\% Duty Cycle, Max) . | $\pm 100 \mathrm{~mA}$ |
| Peak Current (NC1x, NO4x) |  |
| (Pulsed 1ms, 10\% Duty Cycle, Max) . . . . . . . . . . . . . . . . . $\pm 300 \mathrm{~mA}$ |  |
| ESD Rating: |  |
| Human Body Model | . $>8 \mathrm{kV}$ |
| Machine Model | >400V |
| Charged Device Model |  |

## Thermal Information

| Thermal Resistance (Typical, Notes 4, 5) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ | $\theta_{\mathrm{JC}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: | :---: |
| 32 Ld 5x5mm TQFN Package | 30 | 1.5 |
| 36 Ball WLCSP Package | 60 |  |
| Maximum Junction Temperature (Plastic Package). |  |  |
| Maximum Storage Temperature Range |  | to $+150^{\circ}$ |

## Operating Conditions

| Temperature Range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| :---: | :---: |
| Logic Control Input Voltage | OV to $\mathrm{V}_{\mathrm{DD}}$ |
| Analog Signal Range | OV to $V_{\text {DD }}$ |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty

NOTES:
3. Signals on NCx, NOx, COMx, INx, and OEx exceeding $V_{D D}$ or GND by specified amount are clamped. Limit current to maximum current ratings.
4. $\theta_{\mathrm{JA}}$ is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379 for details.
5. For $\theta_{\mathrm{JC}}$, the "case temperature" location is the center of the exposed metal pad on the package underside.

Electrical Specifications - 2.7V to 3.6V Supply Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+2.7 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{NxH}}=1.4 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{NxL}}=0.5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{OExH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{OExL}}=0.5 \mathrm{~V}$, (Note 6), Unless Otherwise Specified.

| PARAMETER | TEST CONDITIONS | $\begin{gathered} \text { TEMP } \\ \left({ }^{\circ} \mathrm{C}\right) \end{gathered}$ | $\begin{gathered} \text { MIN } \\ \text { (Notes 7, 8) } \end{gathered}$ | TYP | MAX (Notes 7, 8) | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH CHARACTERISTICS |  |  |  |  |  |  |
| USB HS Switch, COM2x and COM3x |  |  |  |  |  |  |
| Analog Signal Range, $\mathrm{V}_{\text {ANALOG }}$ |  | Full | 0 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| ON-Resistance, ron High Speed | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 400 \mathrm{mV}(\text { see Figure } 1) \end{aligned}$ | 25 | - | 8.3 | - | $\Omega$ |
|  |  | Full | - | 9.25 | - | $\Omega$ |
| ron Matching Between Channels, ${ }^{\Delta r}$ ON, High Speed | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=\text { Voltage at max roN, (Note 10) } \end{aligned}$ | 25 | - | 0.11 | - | $\Omega$ |
|  |  | Full | - | 0.22 | - | $\Omega$ |
| ron Flatness, ratAT(ON) High Speed | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{ICOMx}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 400 \mathrm{mV} \text {, (Note } 9 \text { ) } \end{aligned}$ | 25 | - | 1.45 | - | $\Omega$ |
|  |  | Full | - | 1.8 | - | $\Omega$ |
| ON-Resistance, ron Full Speed | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \text { (see Figure } 1, \text { Note 11) } \end{aligned}$ | 25 | - | 130 | 150 | $\Omega$ |
|  |  | Full | - | 150 | 178 | $\Omega$ |
| ron Matching Between Channels, $\Delta r_{\text {ON }}$, Full-Speed | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\text {OExH }}, \mathrm{I}_{\mathrm{COMx}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {NOx }}$ or <br> $\mathrm{V}_{\mathrm{NCx}}=$ Voltage at max $\mathrm{r}_{\mathrm{ON}}$ over signal range of 0 V to 2.7 V <br> (Note 10) | 25 | - | 1.2 | - | $\Omega$ |
|  |  | Full | - | 2.6 | - | $\Omega$ |
| ron Flatness, reLAT(ON) Full-Speed | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\text {OExH }}, \mathrm{I}_{\mathrm{COMx}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {NOx }}$ or $\mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V}$ to 1 V (Note 9) | 25 | - | 4 | - | $\Omega$ |
|  |  | Full | - | 5 | - | $\Omega$ |
| ON-Resistance, ron | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 1.8 \mathrm{~V} \text { (see Figure 1) } \end{aligned}$ | 25 | - | 128 | - | $\Omega$ |
|  |  | Full | - | 140 | - | $\Omega$ |
| OFF Leakage Current, $I_{\text {NOx(OFF) }}$ or ${ }^{1} \mathrm{NCx}$ (OFF) | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=$ Such that switch is disabled, <br> $\mathrm{V}_{\text {COMx }}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NOx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V}$ | 25 | -20 | 4 | 20 | nA |
|  |  | Full | -100 | - | 100 | nA |
| ON Leakage Current, $\mathrm{I}_{\text {COMx }}$ (ON) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{COMx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NOx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V} \end{aligned}$ | 25 | -50 | 4 | 50 | nA |
|  |  | Full | -100 | - | 100 | nA |

Electrical Specifications - 2.7V to 3.6V Supply
Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+2.7 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INxH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INxL}}=0.5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{OExH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{OExL}}=0.5 \mathrm{~V}$, (Note 6), Unless Otherwise Specified. (Continued)

| PARAMETER | TEST CONDITIONS | TEMP ( ${ }^{\circ} \mathrm{C}$ ) | $\begin{gathered} \text { MIN } \\ \text { (Notes 7, 8) } \end{gathered}$ | TYP | $\begin{gathered} \text { MAX } \\ \text { (Notes 7, 8) } \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power OFF Leakage Current, $\mathrm{I}_{\mathrm{D}+}, \mathrm{I}_{\mathrm{D}-}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{NOX}}=0 \mathrm{~V} \text { to } 5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCX}}=0 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \text {, } \\ & \mathrm{V}_{\text {INX }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEX}} \text { such that switch is disabled } \\ & \text { (see Figure 5) } \end{aligned}$ | 25 | - | 2 | 100 | nA |
|  |  | Full | - | - | 2 | $\mu \mathrm{A}$ |
| $1 \Omega$ Switch, COM1A and COM4A |  |  |  |  |  |  |
| Analog Signal Range, $\mathrm{V}_{\text {ANALOG }}$ |  | Full | 0 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| ON-Resistance, ron | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEX}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or }$ $\mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V}$ to 2.7 V (see Figure 1, Note 11) | 25 | - | 1.26 | 1.5 | $\Omega$ |
|  |  | Full | - | 1.5 | 1.74 | $\Omega$ |
| $r_{\text {ON }}$ Matching Between Channels, $\Delta{ }^{\prime} \mathrm{ON}$ | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}}$ or $\mathrm{V}_{\mathrm{NCx}}=$ Voltage at max $\mathrm{r}_{\mathrm{ON}}$ over signal range of 0 V to 2.7 V , (Note 10) | 25 | - | 0.05 | - | $\Omega$ |
|  |  | Full | - | 0.07 | - | $\Omega$ |
| ron Flatness, $\mathrm{r}_{\text {FLAT(ON }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \left.\mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \text { (Note } 9\right) \end{aligned}$ | 25 | - | 0.37 | 0.52 | $\Omega$ |
|  |  | Full | - | 0.37 | 0.6 | $\Omega$ |
| ON-Resistance, ron | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 1.8 \mathrm{~V} \text { (see Figure 1) } \end{aligned}$ | 25 | - | 1.3 | - | $\Omega$ |
|  |  | Full | - | 1.4 | - | $\Omega$ |
| OFF Leakage Current, $I_{\text {NOx(OFF) }}$ or ${ }^{1} \mathrm{NCx}$ (OFF) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEX}}=\mathrm{V}_{\mathrm{OExL}}, \mathrm{~V}_{\mathrm{COMx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NOx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V} \end{aligned}$ | 25 | -20 | 4 | 20 | nA |
|  |  | Full | -150 | - | 150 | nA |
| ON Leakage Current, ICOMx(ON) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{COMx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NOx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V} \end{aligned}$ | 25 | -50 | 10 | 50 | nA |
|  |  | Full | -300 | - | 300 | nA |
| $6 \Omega$ Switch, COM1B and COM4B |  |  |  |  |  |  |
| Analog Signal Range, $\mathrm{V}_{\text {ANALOG }}$ |  | Full | 0 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| ON-Resistance, ron | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \text { (see Figure 1, Note 11) } \end{aligned}$ | 25 | - | 8 | 9.2 | $\Omega$ |
|  |  | Full | - | 9.2 | 10.8 | $\Omega$ |
| ron Matching Between Channels, $\Delta \mathrm{r}_{\mathrm{ON}}$ | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\text {OExH }}, \mathrm{I}_{\text {COMx }}=40 \mathrm{~mA}, \mathrm{~V}_{\text {NOx }}$ or $\mathrm{V}_{\mathrm{NC}} \mathrm{x}=$ Voltage at max $\mathrm{r}_{\mathrm{ON}}$ over signal range of 0 V to 2.7 V , (Note 10) | 25 | - | 0.08 | - | $\Omega$ |
|  |  | Full | - | 0.3 | - | $\Omega$ |
| ron Flatness, r ${ }_{\text {FLAT(ON }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \left.\mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \text { (Note } 9\right) \end{aligned}$ | 25 | - | 1.9 | 2.8 | $\Omega$ |
|  |  | Full | - | 1.9 | 3.3 | $\Omega$ |
| ON-Resistance, ron | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{I}_{\mathrm{COMx}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \\ & \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text { to } 1.8 \mathrm{~V} \text { (see Figure 1) } \end{aligned}$ | 25 | - | 8 | - | $\Omega$ |
|  |  | Full | - | 8.8 | - | $\Omega$ |
| OFF Leakage Current, $I_{\text {NOx(OFF) }}$ or ${ }^{1} \mathrm{NCx}$ (OFF) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExL}}, \mathrm{~V}_{\mathrm{COMx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NOx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=3.3 \mathrm{~V}, 0.3 \mathrm{~V} \end{aligned}$ | 25 | -20 | 4 | 20 | nA |
|  |  | Full | -100 | - | 100 | nA |
| ON Leakage Current, ICOMx(ON) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{COMx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NOx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{NCx}}=0.3 \mathrm{~V}, 3.3 \mathrm{~V} \end{aligned}$ | 25 | -50 | 4 | 50 | nA |
|  |  | Full | -130 | - | 130 | nA |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |
| USB HS Switch |  |  |  |  |  |  |
| Skew, tSKEW | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{R}_{\mathrm{L}}=45 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \\ & \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=720 \mathrm{ps} \text { at } 480 \mathrm{Mbps}, \text { Duty Cycle }=50 \% \\ & \text { (see Figure 6) } \end{aligned}$ | 25 | - | 50 | - | ps |
| Total Jitter, $\mathrm{t}_{\mathrm{J}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{R}_{\mathrm{L}}=45 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \\ & \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=750 \mathrm{ps} \text { at } 480 \mathrm{Mbps} \end{aligned}$ | 25 | - | 210 | - | ps |
| Propagation Delay, tPD | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{R}_{\mathrm{L}}=45 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} \\ & \text { (see Figure 6) } \end{aligned}$ | 25 | - | 250 | - | ps |
| OFF-Isolation | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}$ (see Figure 2) | 25 | - | -15 | - | dB |

Electrical Specifications-2.7V to 3.6V Supply Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+2.7 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INxH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INxL}}=0.5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{OExH}}=1.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{OExL}}=0.5 \mathrm{~V}$, (Note 6), Unless Otherwise Specified. (Continued)

| PARAMETER | TEST CONDITIONS | $\begin{aligned} & \text { TEMP } \\ & \left({ }^{\circ} \mathrm{C}\right) \end{aligned}$ | MIN <br> (Notes 7, 8) | TYP | $\begin{gathered} \text { MAX } \\ \text { (Notes 7, 8) } \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HS Switch -3dB Bandwidth, | Signal $=50 \mathrm{mV} \mathrm{RMS}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 25 | - | 500 | - | MHz |
| OFF Capacitance, $\mathrm{C}_{\text {NOxOFF }}$ or $\mathrm{C}_{\text {NCxOFF }}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & \text { (see Figure 3) } \end{aligned}$ | 25 | - | 6.2 | - | pF |
| COM ON Capacitance, C ${ }_{\text {COMxON }}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & \text { (see Figure 3) } \end{aligned}$ | 25 | - | 12.5 | - | pF |
| $1 \Omega$ Switches |  |  |  |  |  |  |
| Crosstalk | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=10 \mathrm{MHz}$ (see Figure 4) | 25 | - | -90 | - | dB |
| OFF-Isolation | $V_{\text {DD }}=3.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=1 \mathrm{MHz}$ (see Figure 2) | 25 | - | 55 | - | dB |
| Switch -3dB Bandwidth | Signal $=50 \mathrm{mV} \mathrm{R}_{\text {RMS }}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 25 | - | 78 | - | MHz |
| OFF Capacitance, $\mathrm{C}_{\text {NOxOFF }}$ or $\mathrm{C}_{\mathrm{NCxOFF}}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & (\text { see Figure 3) } \end{aligned}$ | 25 | - | 21 | - | pF |
| COM ON Capacitance, C ${ }_{\text {COMxON }}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & (\text { see Figure 3) } \end{aligned}$ | 25 | - | 61 | - | pF |
| $6 \Omega$ Switches |  |  |  |  |  |  |
| Crosstalk | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=10 \mathrm{MHz}$ (see Figure 4) | 25 | - | -67 | - | dB |
| OFF-Isolation | $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=10 \mathrm{MHz}$ (see Figure 2) | 25 | - | 50 | - | dB |
| Switch -3dB Bandwidth | $50 \mathrm{mV} \mathrm{VMS}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 25 | - | 310 | - | MHz |
| OFF Capacitance, $\mathrm{C}_{\text {NOxOFF }}$ or $\mathrm{C}_{\text {NCxOFF }}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & (\text { see Figure 3) } \end{aligned}$ | 25 | - | 6 | - | pF |
| COM ON Capacitance, C ${ }_{\text {COMxON }}$ | $\begin{aligned} & f=1 \mathrm{MHz}, \mathrm{~V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{\mathrm{OExH}}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \\ & (\text { see Figure 3) } \end{aligned}$ | 25 | - | 15 | - | pF |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Range, $\mathrm{V}_{\mathrm{DD}}$ |  | Full | 2.7 |  | 3.6 | V |
| Positive Supply Current, IDD | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{OEx}}=\mathrm{V}_{I N x}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COMx}}=0 \mathrm{~V} \end{aligned}$ | 25 | - | 1 | 2 | $\mu \mathrm{A}$ |
|  |  | Full | - | 1.24 | - | $\mu \mathrm{A}$ |
| Power Supply Current, IDD | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {Logic }}=1.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{NOx}} \text { or } \mathrm{V}_{\mathrm{NCx}}=0 \mathrm{~V} \text {, }$ <br> $V_{\text {COMx }}=0 V$. Driving one logic pin only. | 25 | - | 1 | - | $\mu \mathrm{A}$ |
| DIGITAL INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Input Voltage Low, $\mathrm{V}_{\text {INLX }}, \mathrm{V}_{\text {OELX }}$ | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to 3.6 V | Full | - | - | 0.5 | V |
| Input Voltage High, $\mathrm{V}_{\text {INHx }}, \mathrm{V}_{\text {OEHx }}$ | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to 3.6 V | Full | 1.4 | - | - | V |
| Input Current Low, IINLx, IOELX | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to 3.6 V | Full | -50 | 20 | 50 | nA |
| Input Current High, IINHx, IOEHx | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to 3.6 V | Full | -2 | 1 | 2 | $\mu \mathrm{A}$ |

NOTES:
6. $\mathrm{V}_{\text {logic }}=$ Input voltage to perform proper function.
7. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
8. Parameters with MIN and/or MAX limits are $100 \%$ tested at $+25^{\circ} \mathrm{C}$, unless otherwise specified. Temperature limits established by characterization and are not production tested.
9. Flatness is defined as the difference between maximum and minimum value of on-resistance over the specified analog signal range
10. ron matching between channels is calculated by subtracting the channel with the highest max $r_{\mathrm{ON}}$ value from the channel with lowest max $\mathrm{r}_{\mathrm{ON}}$ value, between NCx or NOx.
11. Limits established by characterization and are not production tested.

## Test Circuits and Waveforms



FIGURE 1. $\mathrm{r}_{\mathrm{ON}}$ TEST CIRCUIT


COM is connected to NO or NC during ON capacitance measurement.

FIGURE 3. CAPACITANCE TEST CIRCUIT


Signal direction through switch is reversed, worst case values are recorded.

FIGURE 2. OFF-ISOLATION TEST CIRCUIT


Signal direction through switch is reversed, worst case values are recorded. Repeat test for all switches.

FIGURE 4. CROSSTALK TEST CIRCUIT


NOTE: OEx such that switch is disabled
FIGURE 5. POWER OFF LEAKAGE TEST CIRCUIT

## Test Circuits and Waveforms (Continued)



FIGURE 6A. MEASUREMENT POINTS

|tro - tri| Delay Due to Switch for Rising Input and Rising Output Signals.
|tfo - tfi| Delay Due to Switch for Falling Input and Falling Output Signals
|tskew_0| Change in Skew through the Switch for Output Signals.
|tskew_i| Change in Skew through the Switch for Input Signals.
FIGURE 6B. TEST CIRCUIT

FIGURE 6. SKEW TEST

## Detailed Description

The ISL54230 is a multiprotocol switch containing eight switches configured as a Quad DPDT. Each DPDT switch is independently controlled by a logic pin. The ISL54230 has four switches that are compliant in passing USB2.0 signals and four switches with low ron that can be used to pass analog or digital signals such as audio or UART. It is offered in a 36 ball WLCSP or a 32 Ld $5 m m x 5 m m$ TQFN package for applications which require small package size such as cellphones and PDAs.

The ISL54230 contains four switches capable of passing USB2.0 Full-Speed and High-Speed signals with minimal distortion, two $1 \Omega$ switches and two $6 \Omega$ switches for analog/digital signals. The USB capable switches were designed with low capacitance and high bandwidth to pass USB HS signals (480Mbps) with minimal edge and phase distortion. The $1 \Omega$ switches are designed for passing low bandwidth signals ( $<8 \mathrm{MHz}$ ) and are ideal for switching power lines since the low ON-resistance minimizes power dissipation. The $6 \Omega$ switches are designed to pass audio or data signals up to 100 MHz while maintaining a low ron for good THD performance.
In addition to the four independent logic control pins that control each DPDT switch, the ISL54230 contains two Output Enable (OE) logic pins that permits the IC to disable certain switches giving the user a high degree of flexibility in signal routing. Please see "OE Control Truth Table" on page 3 for an explanation of the OE pins. All logic pins on the ISL54230 are 1.8 V logic compatible up to $\mathrm{a}+3.3 \mathrm{~V}$ supply.

## Power Supply Considerations

The power supply connected to the $V_{D D}$ and GND pins provides the DC bias voltage necessary to operate the IC. The ISL54230 can be operated with a supply voltage in the range of +2.0 V to +5.5 V . For USB applications, the supply voltage should be in the range of +3.0 V to +5.5 V to ensure proper signal levels on the USB data lines.
A decoupling capacitor in the range $0.01 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$ should be connected to the $V_{D D}$ supply pin of the IC to filter out any power supply noise that may be present on the supply lines. The capacitor should be place as closed as possible to the $V_{D D}$ pin.

## Supply Sequencing and Power-On Reset Protection

Proper power supply sequencing is necessary to protect the ISL54230 from operating in fault conditions. The ISL54230 integrates Power-On Reset (POR) circuitry that prevents the switches from turning ON until the supply voltage is at least +1.4 V . The POR has a 100 mV hysteresis built in that will turn the switches OFF when the supply has gone below +1.3 V . This function prevents signals from the switch input being passed to the output when the device operating voltage has not reached appropriate levels yet, protecting the switch from fault conditions.

The POR circuitry also protects the switch from operating in a fault condition should the power supply to the IC drop below the POR threshold. Thus, the recommended operational supply voltage is within +2.0 V to +5.5 V . Operating at supply voltages below +2.0 V may still be functional but the noise margin between the POR threshold and supply voltage will be reduced. The device may
unexpectedly shut down if transient voltages trigger the POR.

## Overvoltage and Short Circuit Considerations

The ISL54230 should be protected from overvoltage conditions. The IC contains ESD protection diodes that are back biased from the switch terminals to ground. Negative voltages on the switch terminals that are large enough to forward-bias these ESD protection diodes will result in a large current flowing from ground that may destroy these diodes. Thus, signals on the switch terminals should not swing below ground and cannot exceed the specified "Absolute Maximum Ratings" on page 5 for safe operation.

The ISL54230 can have signals that go above the positive supply rail with no adverse effects up to +5.5 V . The ESD protection circuitry permits the signal from going beyond the $V_{D D}$ supply (even with $V_{D D}=0 \mathrm{~V}$ ) without inducing large leakage currents on the switch pins when the supply voltage is less than +5.5 V . This feature complies with the USB 2.0 Specifications for short circuit protection in the event that the $5.25 \mathrm{~V} V_{B U S}$ line shorts to the USB signal lines.

Note: When the supply voltage is above the POR threshold and a $V_{B U S}$ fault conditions occurs, the $V_{B U S}$ signal will be passed to the other side of the switch if the logic control pins are biased such that the switch is turned ON.

## USB Switches (COM2x and COM3x)

The four USB FS and HS capable switches are bi-directional analog switches that can pass rail-to-rail signals with minimal distortion. With a 3.0 V power supply, these switches have a nominal ON-resistance of $6 \Omega$ in the 0 V to 400 mV signal range. The low capacitance and high bandwidth of the switches makes them ideal for USB applications. They are specifically designed to pass both USB FS (12Mbps) and USB HS (480Mbps) differential signals while meeting the USB 2.0 signal quality eye diagrams (Figures 25 and 26).
The USB switches are designed with integrated protection circuitry for fault conditions as defined in the USB 2.0 Specifications-Section 7.1.1. If a condition where $V_{B U S}$ $(5.25 \mathrm{~V})$ is shorted to the $\mathrm{D}+$ or D - pin this will not damage the device, even without power to the IC.

## $1 \Omega$ Switches (COM1A and COM4A) and $6 \Omega$ Switches (COM1B and COM4B)

The two $1 \Omega$ switches are bi-directional analog switches that can pass rail-to-rail signals, making them well suited for analog or digital signal routing. The low ON-resistance of the switches makes them ideal for switching ON/OFF power supply lines for applications that interface with devices that require power (ie: SIM cards or flash memory devices). With a ON-resistance of $1 \Omega$ the power dissipation through the switch is minimal.
The two $6 \Omega$ switches are bi-directional analog switches that can pass rail-to-rail signals, making them well suited for
analog or digital signal routing such as audio, UART or Full-Speed USB.

The low ON-resistance of these switches are well suited for passing audio signals with good THD performance, even with low impedance loads such as $32 \Omega$ headphones (see Figure 24 for THD performance curves).

## Logic Control Pins

The ISL54230 contains six logic control pins, IN1 through IN4 for independently controlling each DPDT switch and two OE enable pins. The logic control pins determine the state of the switches. Refer to the "Input Select" and "OE Control" Truth Tables on page 3.
When the OEx control pins are logic LOW, only the switches on COM $2 x$ and COM $3 x$ are active and the switch state determined by IN2 and IN3 respectively. When the OEx control pins are logic HIGH, all switches are active and the switch state determined by the INX control pins.

When the OEx control pins are in opposing logic states either COM $1 x$ and COM $2 x$ are active or COM $3 x$ and COM $4 x$ are active depending on what states OE1 and OE2 are at.
The active switches are controlled by the respective INx control pin. This feature is useful for applications that interface the ISL54230 to Master/Slave devices or controlling two SIM cards in Dual SIM Card cellphones. The OEx control pins permit total deactivation of each half of the switch blocks to disable devices connected to those switches.

## LOGIC CONTROL VOLTAGE LEVELS

OEx = Logic "0" (Low) when $\mathrm{V}_{\mathrm{OEx}} \leq 0.5 \mathrm{~V}$
OEx = Logic " 1 " (High) when $\mathrm{V}_{\mathrm{OEx}} \geq 1.4 \mathrm{~V}$
$\mathrm{INx}=$ Logic " 0 " (Low) when $\mathrm{V}_{\mathrm{INx}} \leq 0.5 \mathrm{~V}$
$\mathrm{INx}=$ Logic " 1 " (High) when $\mathrm{V}_{\text {IN }} \geq 1.4 \mathrm{~V}$
The logic control pins are +1.8 V CMOS logic compatible ( 0.45 V $\mathrm{V}_{\text {OLMAX }}$ and $1.35 \mathrm{~V} \mathrm{~V}_{\text {OHMIN }}$ ) for supply voltages from +1.8 V to +3.6 V . over a supply range of 1.8 V to 3.3 V (see Figure 23 ). At 3.6 V the $\mathrm{V}_{\mathrm{IL}}$ level is 0.5 V maximum. This is still below the 1.8 V CMOS guaranteed low output maximum level of 0.45 V , but noise margin is reduced. At 3.6 V the $\mathrm{V}_{\mathrm{IH}}$ level is 1.4 V minimum. While this is above the 1.8 V CMOS guaranteed high output minimum of 1.35 V under most operating conditions the switch will recognize this as a valid logic high.
The digital input stages draws a larger supply current whenever the digital input voltage is not at one of the supply rails. Driving the digital input signals from GND to V+ with a fast transition time minimizes power dissipation. The ISL54230 has been designed to minimize the supply current whenever the digital input voltage is not driven to the supply rails ( 0 V to $\mathrm{V}+$ ). For example driving the device with 1.8 V logic high while operating with a 3.6 V supply the device draws only $1 \mu \mathrm{~A}$ of current.

## Application Block Diagram



Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified.


FIGURE 7. ON-RESISTANCE vs SWITCH VOLTAGE; COM2x AND COM3x


FIGURE 8. ON- RESISTANCE vs SWITCH VOLTAGE; COM2, COM3

Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 9. ON-RESISTANCE vs SWITCH VOLTAGE; COM2x AND COM3x


FIGURE 11. ON-RESISTANCE vs SWITCH VOLTAGE; COM1A AND COM4A


FIGURE 13. ON-RESISTANCE vs SWITCH VOLTAGE; COM1B AND COM4B


FIGURE 10. ON-RESISTANCE vs SWITCH VOLTAGE; COM2x AND COM3x


FIGURE 12. ON-RESISTANCE vs SWITCH VOLTAGE; COM1A AND COM 4A


FIGURE 14. ON-RESISTANCE vs SWITCH VOLTAGE; COM1B AND COM4B

Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 15. FREQUENCY RESPONSE; COM2x and COM3x


FIGURE 17. FREQUENCY RESPONSE; COM1A AND COM4A


FIGURE 19. FREQUENCY RESPONSE; COM1B and COM4B


FIGURE 16. OFF-ISOLATION; COM2x and COM3x


FIGURE 18. OFF-ISOLATION; COM1A AND COM4A


FIGURE 20. OFF-ISOLATION; COM1B and COM4B

Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 21. CROSSTALK


FIGURE 23. LOGIC INPUT THRESHOLD VOLTAGE vs SUPPLY VOLTAGE



FIGURE 24. TOTAL HARMONIC DISTORTION vs FREQUENCY

Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 25. EYE PATTERN: 12Mbps; COM2x or COM3x SWITCH IN THE SIGNAL PATH

Typical Performance Curves $\quad \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 26. EYE PATTERN: 480Mbps; COM2x or COM 3x SWITCH IN THE SIGNAL PATH
Die Characteristics
SUBSTRATE POTENTIAL (POWERED UP):
GND

## TRANSISTOR COUNT:

1216

## PROCESS:

Submicron, Dual Gate, Analog CMOS

Wafer Level Chip Scale Package (WLCSP)


W6x6.36
6x6 ARRAY 36 BALL WAFER LEVEL CHIP SCALE PACKAGE

| SYMBOL | MILLIMETERS |
| :---: | :---: |
| A | 0.44 Min, 0.495 Nom, 0.55 Max |
| $\mathrm{A}_{1}$ | $0.190 \pm 0.030$ |
| $\mathrm{~A}_{2}$ | $0.305 \pm 0.025$ |
| b | $0.270 \pm 0.030$ |
| D | $2.530 \pm 0.020$ |
| $\mathrm{D}_{1}$ | 2.000 BASIC |
| E | $2.530 \pm 0.020$ |
| $\mathrm{E}_{1}$ | 2.000 BASIC |
| e | 0.400 BASIC |
| SD | 0.200 BASIC |
| SE | 0.200 BASIC |
| Number of Bumps: 36 |  |

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NOTES:

1. Dimensions are in millimeters.


BOTTOM VIEW

Thin Quad Flat No-Lead Plastic Package (TQFN) Thin Micro Lead Frame Plastic Package (TMLFP)


L32.5x5A
32 LEAD THIN QUAD FLAT NO-LEAD PLASTIC PACKAGE (COMPLIANT TO JEDEC MO-220WJJD-1 ISSUE C)

| SYMBOL | MILLIMETERS |  |  | NOTES |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOMINAL | MAX |  |
| A | 0.70 | 0.75 | 0.80 | - |
| A1 | - | - | 0.05 | - |
| A3 | 0.20 REF |  |  | - |
| b | 0.18 | 0.25 | 0.30 | 5, 8 |
| D | 5.00 BSC |  |  | - |
| D2 | 3.30 | 3.45 | 3.55 | 7, 8 |
| E | 5.00 BSC |  |  | - |
| E1 | 5.75 BSC |  |  | 9 |
| E2 | 3.30 | 3.45 | 3.55 | 7, 8 |
| e | 0.50 BSC |  |  | - |
| k | 0.20 | - | - | - |
| L | 0.30 | 0.40 | 0.50 | 8 |
| N |  | 32 |  | 2 |
| Nd |  | 8 |  | 3 |
| Ne |  | 8 |  | 3 |

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NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
2. N is the number of terminals.
3. Nd and Ne refer to the number of terminals on each $D$ and $E$.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension $b$ applies to the metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip.
6. The configuration of the pin \#1 identifier is optional, but must be located within the zone indicated. The pin \#1 identifier may be either a mold or mark feature.
7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.


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